

General Description

The STD70N10F4 use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

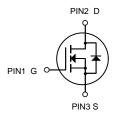
This device is specially designed to get better ruggedness.



General Features

V_{DS} =100V I_D =60A

 $R_{DS(ON)}$ < 17m Ω @ V_{GS} =10V



Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications

N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
STD70N10F4	TO252-2L	HXY MOSFET	2500

Absolute Maximum Ratings at Tj=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	VDS	100	V
Gate source voltage	VGS	±20	V
Continuous drain current ¹⁾	ID	60	А
Pulsed drain current ²⁾	ID, pulse	180	А
Power dissipation ³⁾	P _D	67.5	W
Single pulsed avalanche energy ⁵⁾	EAS	80	mJ
Operation and storage temperature	Tstg, Tj	-55 to 150	°C
Thermal resistance, junction-case	RθJC	1.85	°C/W
Thermal Resistance Junction-Ambient ¹	RθJA	45	°C/W



Electrical Characteristics (T_J= 25°C, unless otherwise noted)

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics		1			I	ı		
Drain-Source Breakdown Voltage		V _{(BR)DSS}	V _{GS} = 0V, I _D = 250µA	100	-	-	V	
Gate-Body Leakage Current		Igss	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA	
Zero Gate Voltage Drain Current	T _J =25°C		V 400V V 0V	-	-	1	μА	
	T _J =100°C	- I _{DSS}	V _{DS} = 100V, V _{GS} = 0V	-	-	100		
Gate-Threshold Voltage	Gate-Threshold Voltage		V _{DS} = V _{GS} , I _D = 250µA	1	1.7	2.5	V	
Dania Common de Bonistano	.4	_	V _{GS} = 10V, I _D = 20A	-	13.5	17	mΩ	
Drain-Source on-Resistance) ⁺	R _{DS(on)}	V _{GS} = 4.5V, I _D = 10A	-	17	20		
Forward Transconductance	1	g fs	V _{DS} = 10V, I _D = 20A	-	54	-	S	
Dynamic Characteristic	s ⁵		•	•		•		
Input Capacitance		Ciss		-	1208	-		
Output Capacitance		Coss	V _{DS} = 50V, V _{GS} =0V, f =1MHz	-	144	-	pF	
Reverse Transfer Capacitance		C _{rss}		-	11.3	-		
Gate Resistance	Gate Resistance		f=1MHz	-	1.8	-	Ω	
Switching Characteristi	CS ⁵		•	•		•		
Total Gate Charge		Qg		-	22.7	-	nC	
Gate-Source Charge		Q _{gs}	$V_{GS} = 10V, V_{DS} = 50V,$ $I_{D} = 20A$	-	3	-		
Gate-Drain Charge		Q_{gd}		-	5	-		
Turn-on Delay Time		t _{d(on)}		-	9.2	-	. ns	
Rise Time		t _r	V _{GS} =10V, V _{DD} = 50V,	-	3.6	-		
Turn-off Delay Time		$t_{d(off)}$	$R_G = 3\Omega$, $I_D = 20A$	-	25.6	-		
Fall Time		t _f		-	4.4	-		
Body Diode Reverse Recovery Time		t _{rr}		-	30	-	ns	
Body Diode Reverse Recovery Charge		Qrr	- I _F = 20A, dl/dt = 100A/μs	-	42	-	nC	
Drain-Source Body Dioc	de Charactei	ristics	•	•		•		
Diode Forward Voltage ⁴		V _{SD}	I _S = 20A, V _{GS} = 0V	-	-	1.2	V	
Continuous Source Current	T _C =25°C	Is	-	-	-	60	Α	

Notes:

- 1. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150°C.
- 2. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.4mH, I_{AS} =20A.
- 3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- 4. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 5. This value is guaranteed by design hence it is not included in the production test..



Typical Characteristics

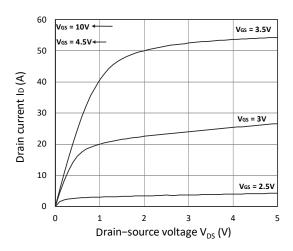


Figure 1. Output Characteristics

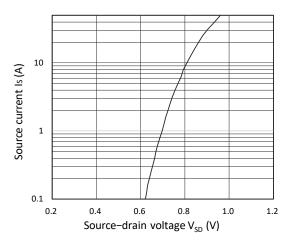


Figure 3. Forward Characteristics of Reverse

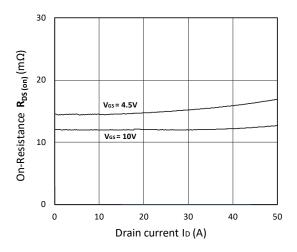


Figure 5. $R_{DS(ON)}$ vs. I_D

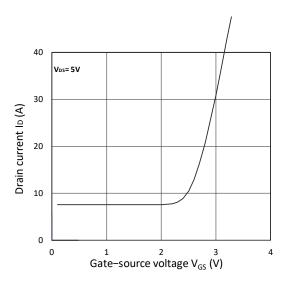


Figure 2. Transfer Characteristics

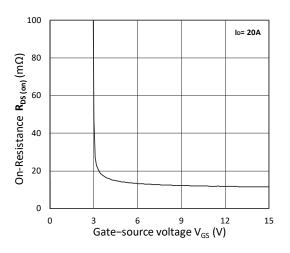


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

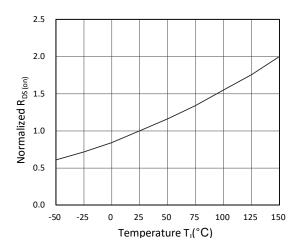


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

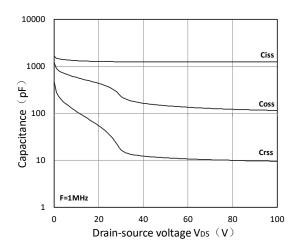


Figure 7. Capacitance Characteristics

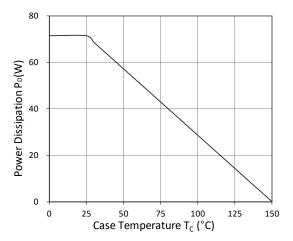


Figure 9. Power Dissipation

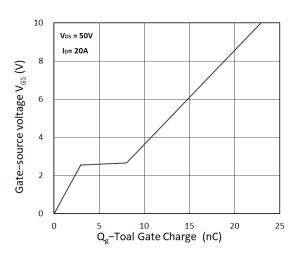


Figure 8. Gate Charge Characteristics

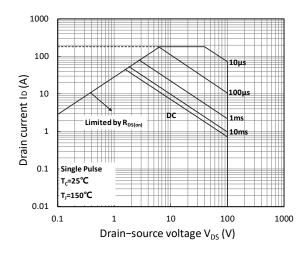


Figure 10. Safe Operating Area

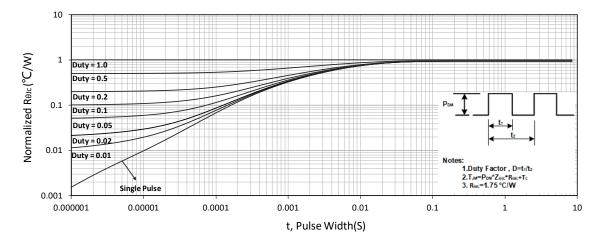


Figure 11. Normalized Maximum Transient Thermal Impedance



Test Circuit

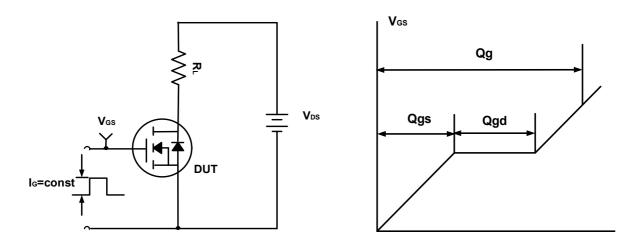


Figure A. Gate Charge Test Circuit & Waveforms

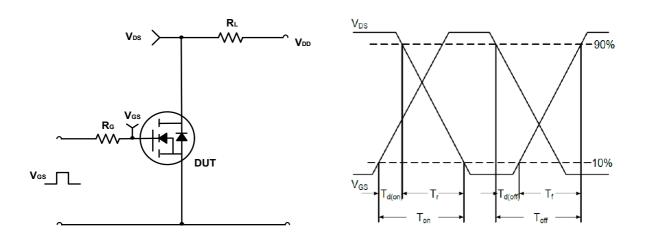


Figure B. Switching Test Circuit & Waveforms

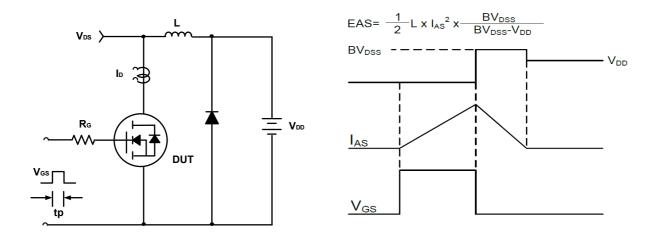
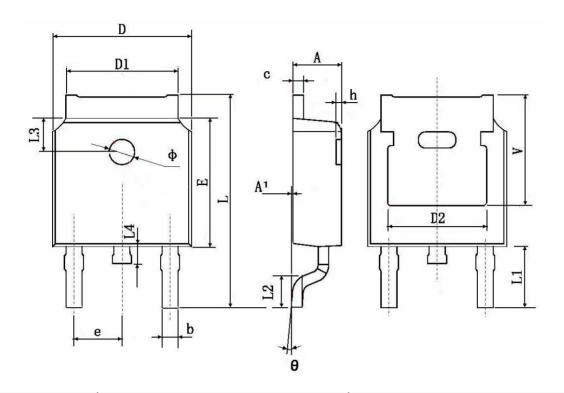


Figure C. Unclamped Inductive Switching Circuit & Waveforms



TO252-2L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
А	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	0.483	TYP.	0.190 TYP.			
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900 TYP.		0.114 TYP.			
L2	1.400	1.700	0.055	0.067		
L3	1.600	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039		
Ф	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350 TYP.		0.211 TYP.			



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